G6ALU 20W FET PA – Construction Information

The requirement

This amplifier was designed specifically to complement the Pic-A-Star transceiver developed by Peter Rhodes G3XJP. From the band pass filter an output of approximately –10dBm can be obtained, this requires amplifying to a useable power level to be of use. Although developed for a specific application the design presented here is flexible enough to be used with any low level HF signal source. Adjustment of the attenuator value and possible removal of the first stage can accommodate a higher input power.

Circuit description

A 3 stage topology has been used requiring a nominal input of –13dBm (0.05mW) for an output of 20W at 1.8MHz falling to 16W at 30MHz (typically 25W on 80M). Typical current consumption is 2.7Amps @ 13.8V, giving a stage efficiency of 53% at 20W output.

Field effect transistors have been used for the power stages, these are low cost and have so far proven to be very robust. One failure mode that must be looked out for is excessive device dissipation; ensure that the gate is not left "floating". If for any reason there isn't a DC connection the gate may rise in voltage and turn the device on drawing excessive current leading to device failure. The devices used here are in a TO220 package which differ from switching devices in that the tab is connected to the source electrode, so in this design are grounded by the PCB and heat sink. No insulating washers are used when bolting the devices down to the heat sink and PCB.

To ensure a good match to the band pass filters a 5dB attenuator has been incorporated before Q1, this is required as the input impedance will vary with frequency. When used with the Pic A Star any additional attenuation required should be placed in the IF stage – refer to the STAR "Set up information" document.

The first gain stage follows the input attenuator, this is a simple common emitter bipolar circuit using emitter feedback, the gain of which is set by the load impedance of T2 (200 Ohms) and that of emitter resistor R8 (33 Ohms). These components set the voltage gain at about 8 or 18dB power gain.

Stage 2 comprises of two field effect transistors (FETs), as previously stated no negative feedback is provided giving a stage gain of about 23dB, providing ½ watt of drive to the output stage. FETs are broadband devices, if driven from a constant voltage source their output can be expected to be flat across the HF band. Unfortunately FETs have a relatively high input capacitance, in the case of the RD06HHF1s used here it is about 27pF giving a capacitive reactance of 196 Ohms @ 30Mhz. Rather than trying to provide a broad-band match to this reactance it is simpler just to load the gate with a resistor of much smaller value, this does of course limit the stage gain but to me 23dB is still quite adequate! Q2 and Q3 gates are loaded with 100R resistors, these also provide a DC path for the bias voltage.

Matched device pairs haven't been used so separate gate bias is provided for each device, this bias is provided from a common source; ZD1 a 5.6 volt zener diode in series with D1 giving some temperature compensation. The driver transistors are running with a quiescent current set at 125mA each, gate load resistors R10 and R11 are decoupled to ground via C9 and C10 so T2 "sees" a total load of 200 Ohms. The output load of Q2 and Q3 is provided by a centre-tapped transformer wound on a BN43-1502 or Epcos B62152A4X1 type core. As the two types have different A_L values, different winding instructions are given for each.

The output stage is very similar to that of the driver having a gain of about 21dB, the main difference being with the output transformer arrangement and gate load resistors. This transformer consists of two cores, the primary of each are connected in series and the outputs in parallel, this arrangement ensures that both transistor drains are tightly coupled in anti-phase so giving good even harmonic suppression. The quiescent current of each transistor is set to 250mA.

Construction

The PCB has been designed to have a continuous ground plane on the underside with connecting tracks on the top. To enable a PCB to be manufactured using your preferred method I have included a reversed positive plot of the top side, when plotting ensure that Acrobat isn't resizing the plot for you by checking with the 100mm reference provided.

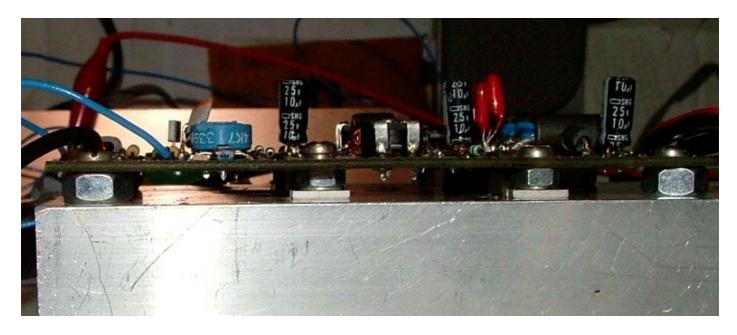
As they are easier to apply and have lower parasitic inductance, surface mount capacitors have been used where practical, in addition all transformers are surface mounted. Other components are leaded types and pass through the PCB, note that anywhere a grounded lead passes through the PCB it should be soldered top and bottom, in addition there are 6 through board links that need soldering both sides. All non-grounded leads which pass through the board should have the ground plane relieved on the underside.

Transformer winding - All transformers are simple to wind, wire diameter for transformers T1 and T2 isn't critical. For T3 don't be tempted to greatly increase the diameter of wire although the core holes would allow it, using a wire significantly thicker increases its self capacitance affecting the transformer wide band performance.

The one turn primary of T4 and T5 can be made from a piece of braid removed from RG58 or similar coax, for the secondary winding use PVC covered hook up wire. Use the heaviest type that will pass through the cores.

As previously noted no insulating washers are used between the heat sink, transistors and PCB. A direct ground connection must be made between the PCB and heat sink, grounding for the Fets is mainly made via their tabs. Two options are provided for output HF compensation, the low cost route is to use two 1nF surface mount ceramic capacitors but due to their questionable suitability (due to max current handling) provision has been made for a 2n2 silver mica part. So far though there are no reported failings of ceramic capacitors, the choice is yours.

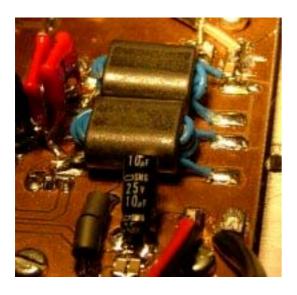
The following pictures are of the prototype, some component positions have changed with the published version.



Method I used to space PCB from heatsink, note the carefully chosen nuts and washers used as spacers.



Picture showing component mounting methods and a melted preset.. it was the prototype!



Output transformer mounting detail.

Testing and alignment

Before applying power check and make sure there are no bridges between any pads and the ground plane. Turn all bias presets anticlockwise (lowest bias voltage). Momentarily apply a supply to the 13V8 terminal and check current drawn is practically zero; C28 will draw initial charging current.

Apply supply to the Bias input and separately to the 13V8 input via an ammeter capable of reading 1 Amp, connect a power meter and 50-Ohm dummy load to the output. Adjust VR1 for a quiescent current of 125mA, VR2 for an increase of 125mA (250mA total), VR3 for an increase of 250mA (500mA total) and finally VR4 for another 250mA increase giving 750mA total quiescent current. Bias adjustment will be sensitive but actual values achieved aren't critical. At this stage there shouldn't be any RF power appearing at the dummy load!

Disconnect power, attach to the band pass filter transmit output of the STAR and apply power. Select 80M and adjust the drive level to a low level, with key down slowly increase the drive and monitor the output level. If an oscilloscope is available monitor the output waveform, it should be easy to achieve an output of 20W on 80M before the output becomes distorted. Repeat drive adjustment for all bands.

In Use

Note that the input and output circuits are "floating", in normal use the coaxial screen connection will be linked to the PCB ground pad. This facility has been provided for situations where a specific cabinet construction generates a ground loop, a floating input or output may "break" the loop.

No output filter is provided, the amplifier still has considerable gain in to the VHF region so must be used with an effective low pass filter, typically the second harmonic is 40dB down on carrier but third harmonic only 25dB down.

When used with a STAR the bias supply is provided directly by the timer board (12V Tx PA bias) and 13V8 terminal left permanently connected to supply, the transistors were developed for use in mobile equipment so can be safely supplied with higher than the normal shack voltage of 13.8V. For an increase in output up to 14.5V may be used safely.

Component Sources

Q1 is specified as a ZTX327 or ZTX313, both of which are now obsolete! An alternative may be the MPSH10 or indeed any other RF transistor of suitable current and frequency rating, watch the pin outs though and adjust C3 to compensate the HF end of band.

The FET devices were obtained from European Microwave Components, contact details:

European Microwave Components Ltd. 36 Priors Way Business Park, Coggeshall, Essex.
United Kingdom.
CO6 1TW

Web http://www.emc.uk.com and email sales@emc.uk.com, note that their minimum order charge before VAT is £25, the value of transistors used in this design total about £8.00!

Ferrite cores can be obtained from any of the normal vendors; no doubt substitutions can be made especially with T1 - T3 whose characteristics aren't critical.

Change log:

28-04-05 Corrected input power requirements following robustness test

Changed harmonic output level Added note about PCB grounding Added note on through board links

Added notes on transformer construction

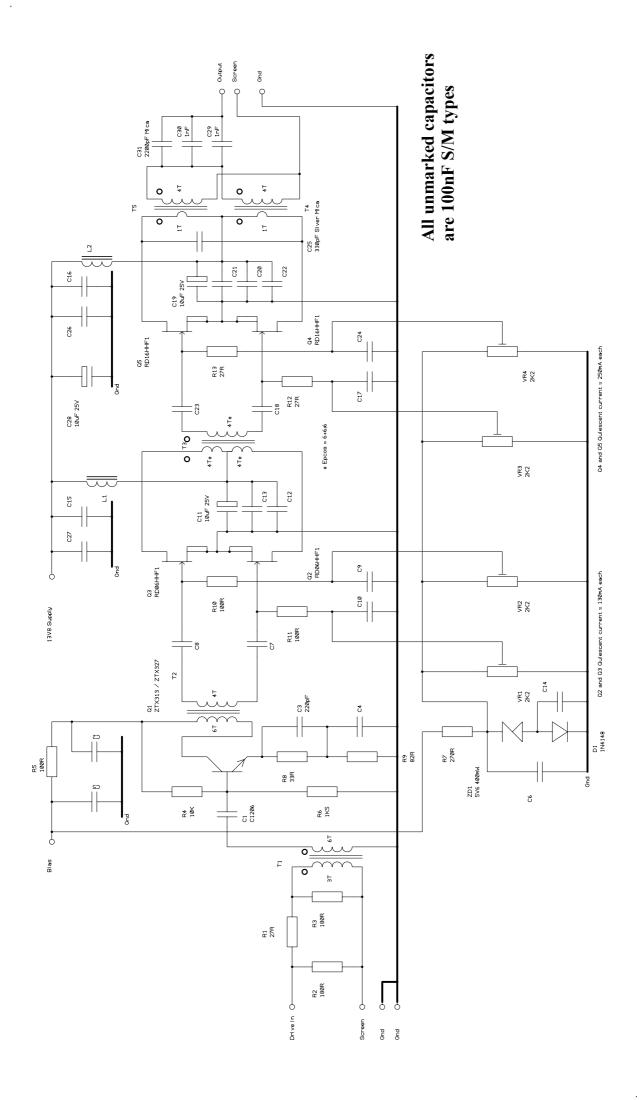
02-05-05 Corrected value of C3 in parts list to 220pF

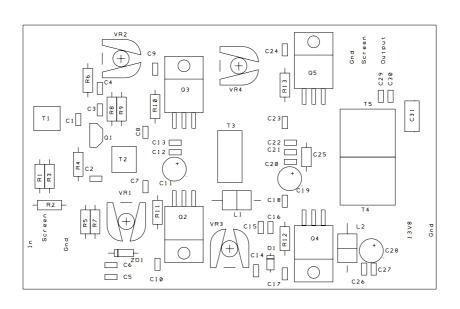
03-04-06 Input attenuator changed from 10dB to 5dB, additional attenuation now placed in IF stage.

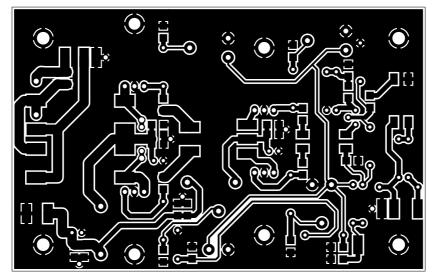
R2 and R3 were 100R, now 180R. R1 was 68R now 27R

20W HF PA Component list

Quantity	Component reference	Description	Notes	Function
	-			
	C1, 2, 4, 5, 6, 7, 8, 9, 10,			
23	12, 13, 14, 15, 16, 17,			
	18, 20, 21, 22, 23, 24,	100=5 1000 014		Counting door line
	26, 27	100nF 1206 SM 10uF 25V PC		Coupling - decoupling
3	C11 10 20			I E decoupling
	C11, 19, 28	electrolytic 330pF Silver Mica >		LF decoupling HF frequency compensation
1	C25	100V	Can be made up of multiple capacitors	of T4 & T5
	020	100 V	Can be made up of multiple capacitors	LF frequency compensation
2	C29, 30	1nF 1206 SM	Not used if C31 fitted, see text	for T4 & T5
1	C3	220pF 1206 SM		HF peaking for Q1
		- 1		LF frequency compensation
1	C31	2200pF Silver Mica	Not used if C29 & 30 fitted, see text	for T4 & T5
1				Partial temperature
	D1	1N4148		compensation for bias supply
1	ZD1	5V6 400mW		Bias voltage regulation
1	Q1	ZTX313, ZTX327		First stage amplification
2	Q2, Q3	RD06HHF1	See text	Second stage amplification
2	Q4, Q5	RD16HHF1	See text	Third stage amplification
	Q+, Q0	IND TOTAL T	occ text	Triild Stage amplification
				R5 decoupling, R10 & R11
				load for 1st stage amplifier
3				and gate reactance swamp
	R5, R10, R11	100R		resistors
				R1 part of input attenuator.
3				R12, 13 Gate reactance
3				swamping resistors for Q4
	R1, R12, R13	27R		and 5
1	R4	10K		Part of Q1 bias
1	R6	1K5	Desire Water to the 10 0M and side to 0 0M ME	Part of Q1 bias
1	D7	2700	Resistor will dissipate about 0.3W so miniature 0.6W MF	Series resistor for FET bias
2	R7 R2, R3	270R 180R	recommended	supply Input attenuator
1	R8	33R		Q1 gain setting
1	R9	82R		Q1 emitter resistor
'	110	OZIK	Unless otherwise stated all resistors 1/8 watt or higher , 5%	Q 1 CHILLET TOOLOG
			tolerance or better	
4		2K2 Horizontal		
4	VR1, VR2, VR3, VR4	preset		Q3-6 gate bias setting
	<u> </u>			
1			2 passes of 0.25mm enamelled copper wire through 2 type 43	<u> </u>
·	L1	2* type 43 beads	beads - see photos	Supply decoupling
1	1.0	0* 5 40 5	1 pass of 1.25mm tinned copper wire through 2 type 43 beads -	Overally decreased to
	L2	2* type 43 beads	see photos	Supply decoupling
			Primary 3 turns, secondary 6 turns of 0.25mm enamelled	
1	T1	BN43-2402	copper wire wound on to BN43-2402 core	
		D.11-10 2-TUZ	Primary 6 turns, secondary 4 turns of 0.25mm enamelled	
1	T2	BN43-2402	copper wire wound on to BN43-2402 core	
			Primary 8 turns centre tapped (I.E. 4+4), secondary 4 turns	
		BN43-1502 or	0.25mm enamelled copper wire wound on type BN43-1502 or	
1		Siemens (Epcos)	for Epcos B62152A4X1 core, 12 turns centre tapped primary	
	T3	B62152A4X1	with 6 turn secondary.	
			Primary 1 turn of braid removed from RG58 cable or similar,	
2			secondary 4 turns of PVC covered hook up wire wound on	
	T4, T5	BN43-202	BN43-202 core - see photo.	
		-		







100mm Reference scale